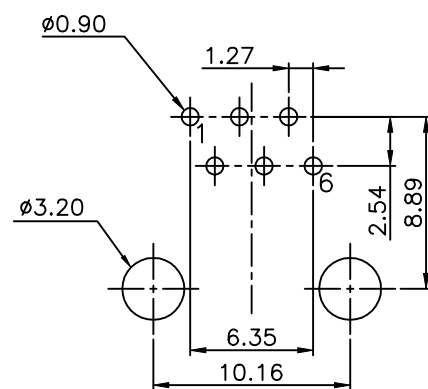
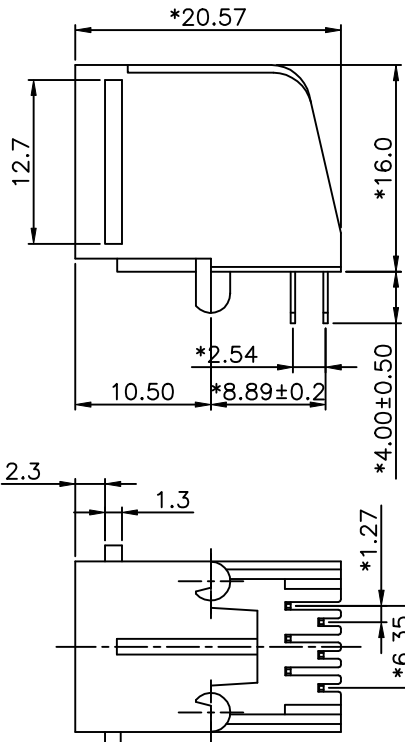
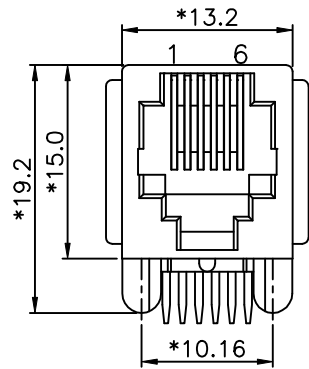




NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS MIN.
2. CURRENT RATING : 1.5 AMP MIN.
3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : GLASS FILLED POLYESTER UL94V-0.
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.
3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.
2: TAILS- TIN PLATING OVER NICKEL.
4. OPERATING LIFE : 750 CYCLES MIN.
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. WAVE SOLDER TEMPERATURE : 230°C TO 250°C 3~5 SECOND.

MATES WITH MODULAR PLUG CONFORMING TO

FCC PART 68, SUBPART F.

CUL FILE NO. E163191

PART NUMBER: E576X-0000XX-L

- 2-2C 1- 3u" 2- 6u"
4-4C 3-15u" 4-30u"
6-6C 5-50u" 6-Pd 20u"
1-W/ PANEL STOP
2-W/O PANEL STOP

DETACHED LISTS	MM (INCH)		DFTO ANKUE	DATE 07/13/05	FULL RISE ELECTRONIC CO., LTD		
	TOLERANCES EXCEPT AS NOTED		CHKDSAMMY	DATE 2005/07/13			
			MFO	DATE	TITLE		
			APPVLLUSHENG	DATE 2005/07/15			
			MATERIAL :				
			SIDE ENTRY PCB JACK				
	ANGLES ± 0.5		QT'Y :				
			FINISH :				
THIRD ANGLE PROJECTION		SCALE :					
		DO NOT SCALE DRAWING			SHEET OF		